

Release HS 20 W

(Provisional)
OBSOLETE

Description

RELEASE HS 20 W is an aqueous polymer dispersion, suitable for hot-stamping applications.

Storing

Protect from freeze. Keep at temperatures between +5 and +40°C.

Application

RELEASE HS 20 W is designed to be coated on BOPET. It provides a good adhesion for metalization and/or printing and allows an easy release after the heat transfer step.

Technical Specifications

Method of analysis	MU	Standard
Solvents		water
1. Total Solids	%	
RELEASE HS 20 W		20±1
3. Brookfield Viscosity 25°C	mPa.s	
RELEASE HS 20 W		< 300
8. pH	pH	
RELEASE HS 20 W		6 - 8

Handling

Apply 6-7 g/sqm wet on the film with traditional coating systems (rotogravure, Mayer bar,...).